

Features

- Uses CRM(CQ) advanced Trench MOS technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Qualified according to JEDEC criteria

Product Summary

V_{DS}	65V
$R_{DS(on)}$ typ.	6.9mΩ
I_D	85A

100% DVDS Tested

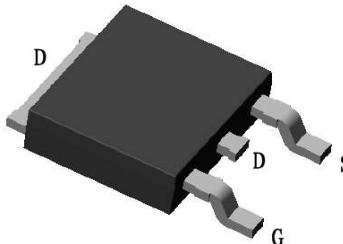
Applications

- Motor control and drive
- Battery management
- UPS (Uninterruptible Power Supplies)

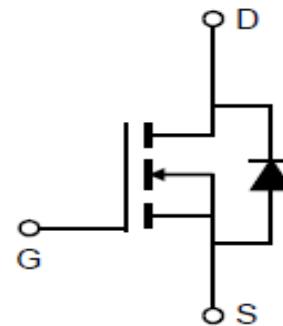
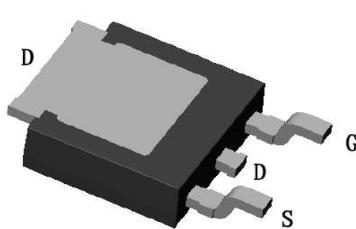
100% Avalanche Tested


TO-252

Top View



Bottom View


Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRTD082NE6N	CRTD082NE6N	TO-252	Reel	N/A	N/A	2500pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	65	V
Continuous drain current $T_C = 25^\circ\text{C}$ (Silicon limit) $T_C = 25^\circ\text{C}$ (Package limit) $T_C = 100^\circ\text{C}$ (Silicon limit)	I_D	85 87 54	A
Pulsed drain current ($T_C = 25^\circ\text{C}$, t_p limited by $T_{j,\max}$)	$I_{D\text{ pulse}}$	340	A
Avalanche energy, single pulse ($L=0.5\text{mH}$, $R_g=25\Omega$)	E_{AS}	100	mJ
Gate-Source voltage	V_{GS}	± 20	V
Power dissipation ($T_C = 25^\circ\text{C}$)	P_{tot}	99	W
Operating junction and storage temperature	T_j, T_{stg}	-55...+150	°C
Soldering temperature, wave soldering only allowed at leads (1.6mm from case for 10s)	T_{sold}	260	°C

Thermal Resistance

Parameter	Symbol	Max	Unit
Thermal resistance, junction - case.	R _{thJC}	1.26	°C/W
Thermal resistance, junction - ambient(min. footprint)	R _{thJA} *	134	

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV _{DSS}	65	-	-	V	V _{GS} =0V, I _D =250uA
Gate threshold voltage	V _{GS(th)}	2	3	4	V	V _{DS} =V _{GS} , I _D =250uA
Zero gate voltage drain current	I _{DSS}	-	0.05	1	μA	V _{DS} =65V, V _{GS} =0V
		-	-	100	μA	T _j =25°C
Gate-source leakage current	I _{GSS}	-	±1	±100	nA	V _{GS} =±20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	6.9	8.4	mΩ	V _{GS} =10V, I _D =40A,
		-	13.3	16.0	mΩ	T _j =25°C
Transconductance	g _{fs}	-	103	-	S	V _{DS} =5V, I _D =40A

Dynamic Characteristic

Input Capacitance	C _{iss}	-	3275	-	pF	V _{GS} =0V, V _{DS} =32V, f=1MHz
Output Capacitance	C _{oss}	-	312	-		
Reverse Transfer Capacitance	C _{rss}	-	225	-		
Gate Total Charge	Q _G	-	73	-	nC	V _{GS} =10V, V _{DS} =32V, I _D =40A, f=1MHz
Gate-Source charge	Q _{gs}	-	19.5	-		
Gate-Drain charge	Q _{gd}	-	26	-		
Turn-on delay time	t _{d(on)}	-	10	-	ns	V _{GS} =10V, V _{DD} =32V, R _{G_ext} =2.7Ω, ID=40A
Rise time	t _r	-	84	-		
Turn-off delay time	t _{d(off)}	-	81	-		
Fall time	t _f	-	83	-		
Gate resistance	R _G	-	5.3	-	Ω	V _{GS} =0V, V _{DS} =0V, f=1MHz

Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V _{SD}	-	0.9	1.3	V	V _{GS} =0V, I _{SD} =40A
Body Diode Continuous Forward Current	I _S			85	A	T _C = 25°C
Body Diode Reverse Recovery Time	t _{rr}	-	29	-	ns	I _F =40A, dI/dt=100A/μs
Body Diode Reverse Recovery Charge	Q _{rr}	-	33	-	nC	

*The value of R_{thJA} is measured by placing the device in a still air box which is one cubic foot.

Typical Performance Characteristics

Fig 1: Output Characteristics

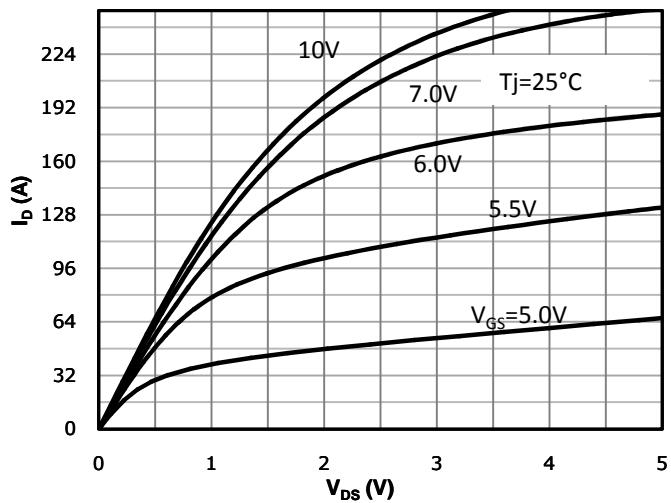


Fig 2: Transfer Characteristics

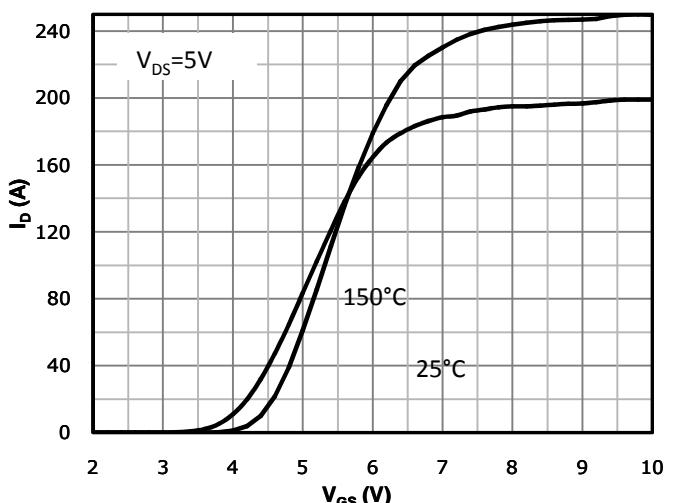


Fig 3: $R_{DS(on)}$ vs Drain Current and Gate Voltage

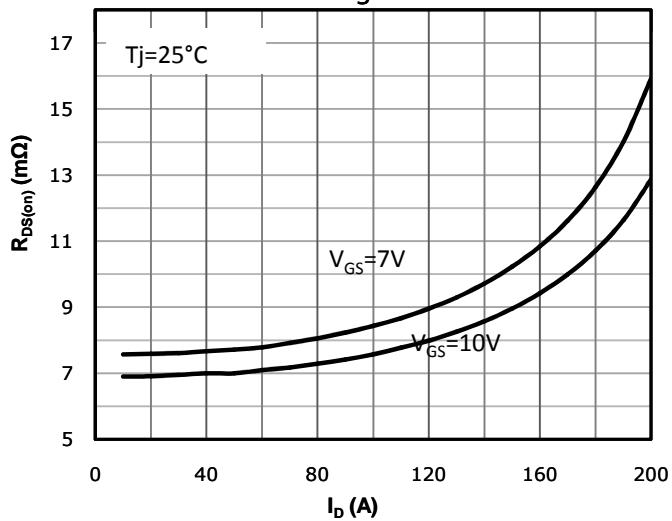


Fig 4: $R_{DS(on)}$ vs Gate Voltage

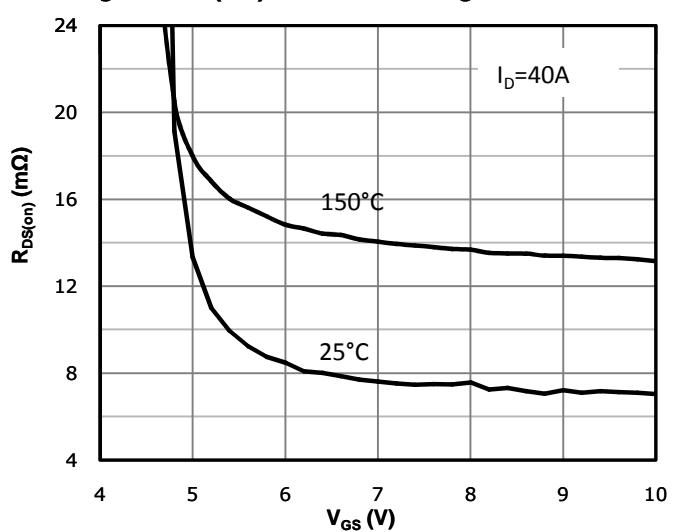


Fig 5: $R_{DS(on)}$ vs. Temperature

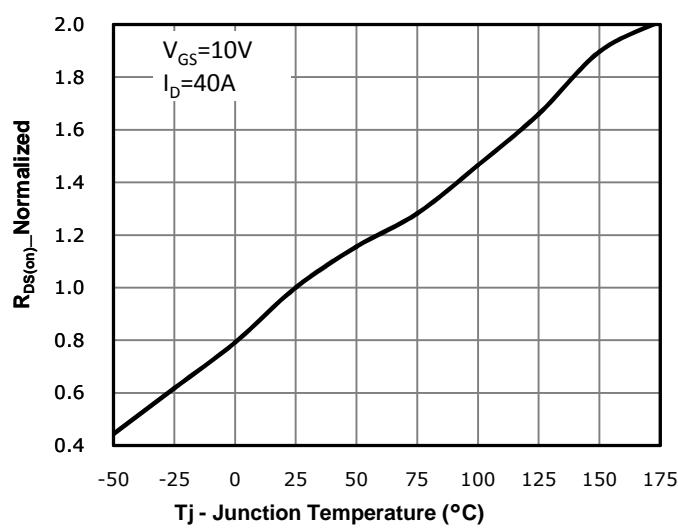


Fig 6: Capacitance Characteristics

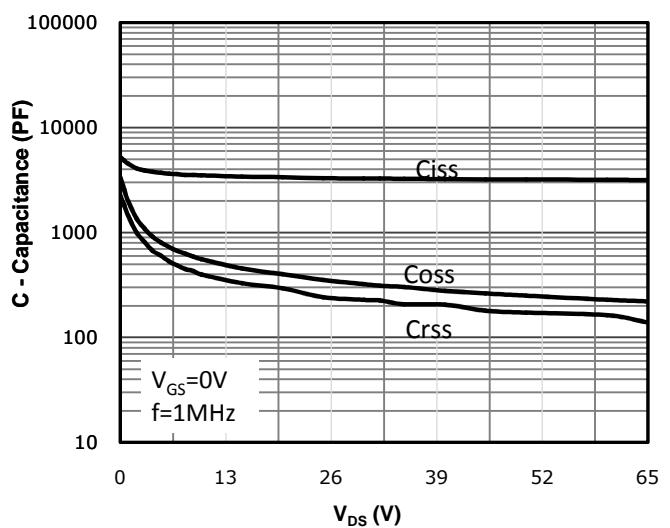


Fig 7: Gate Charge Characteristics

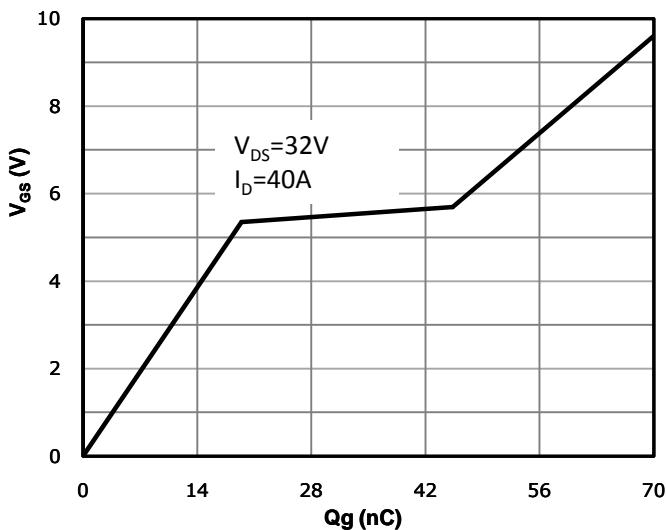


Fig 8: Body-diode Forward Characteristics

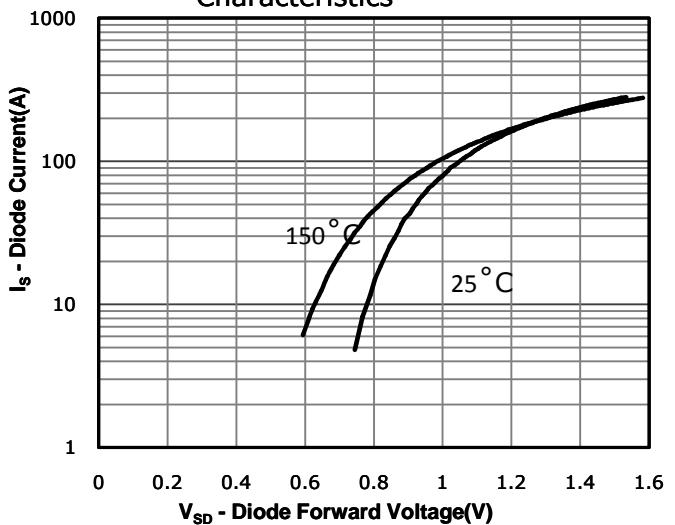


Fig 9: Power Dissipation

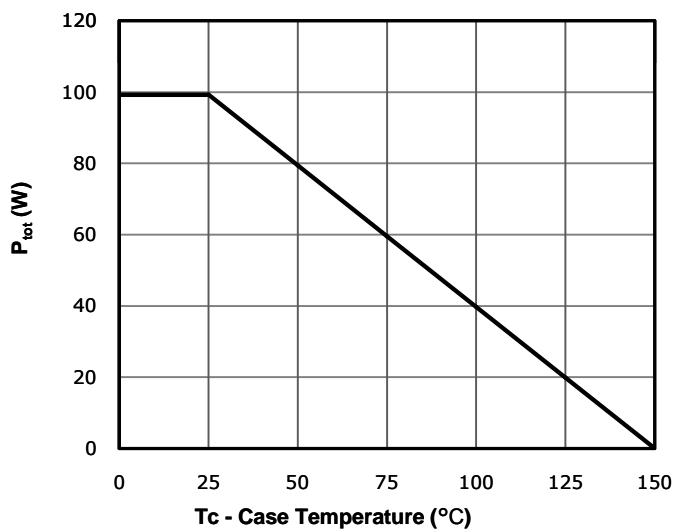


Fig 10: Drain Current Derating

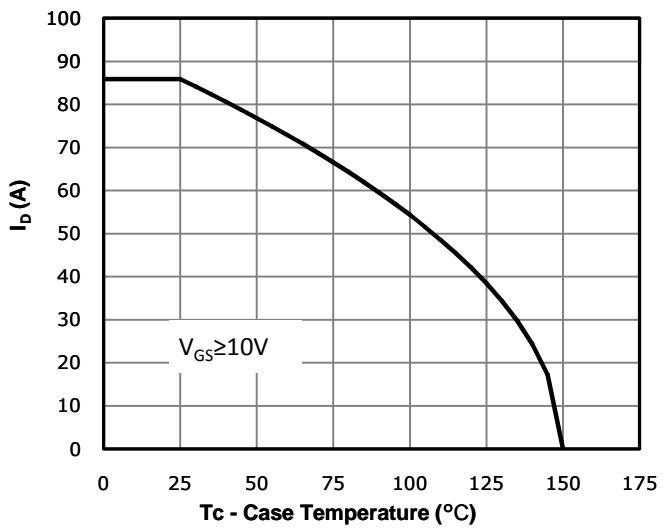


Fig 11: Safe Operating Area

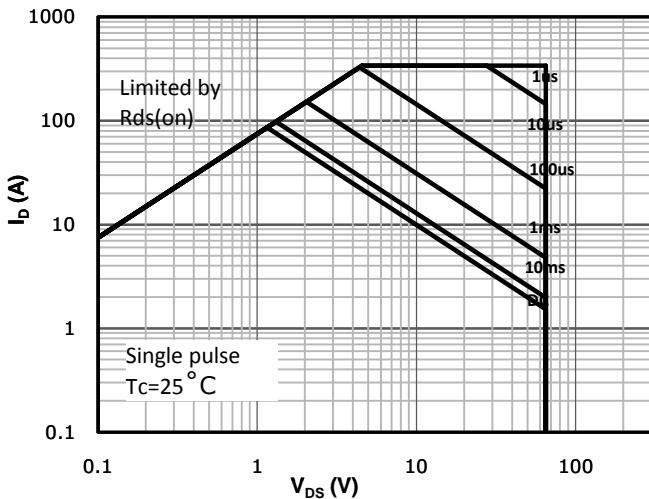
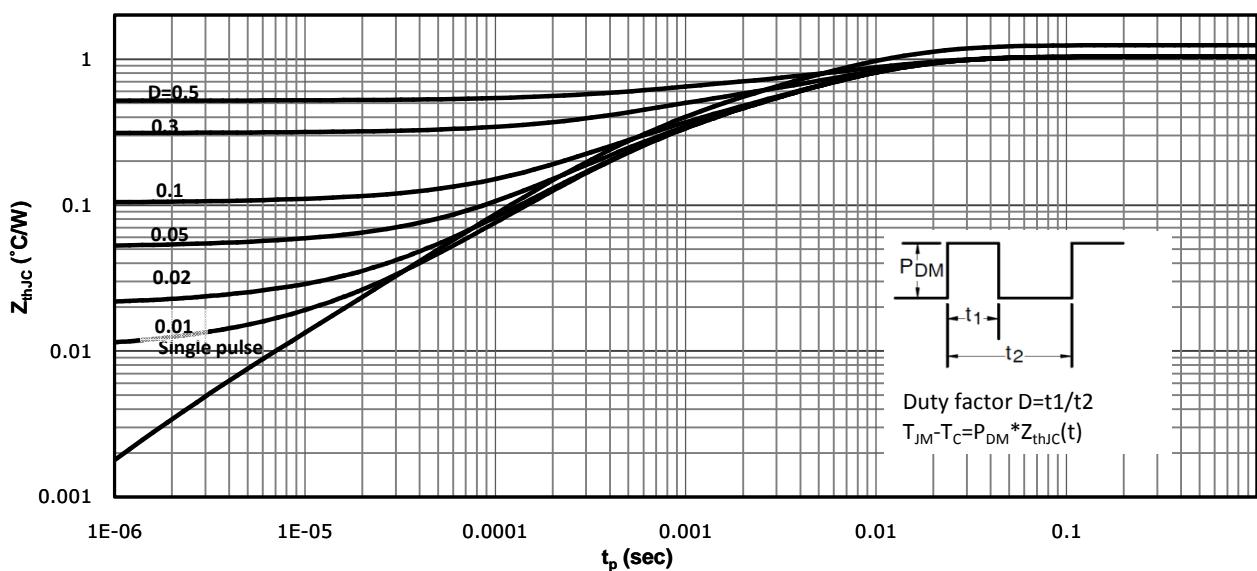
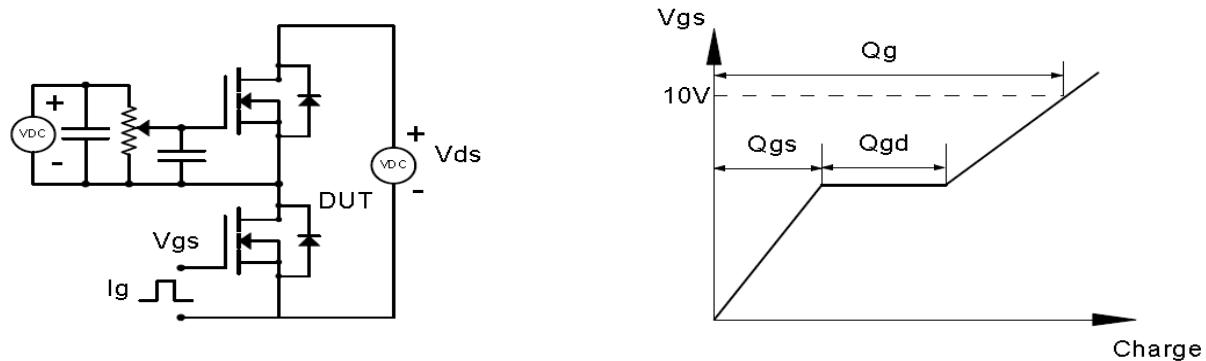


Fig 12: Max. Transient Thermal Impedance

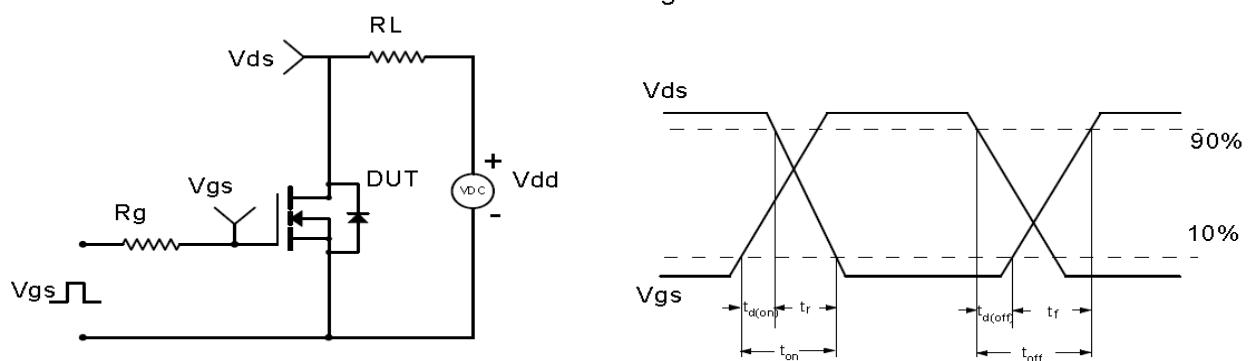


Test Circuit & Waveform

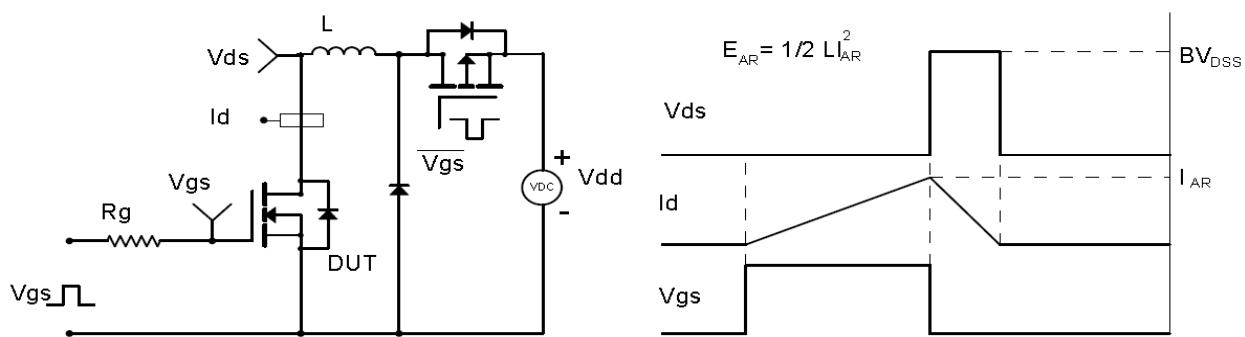
Gate Charge Test Circuit & Waveform



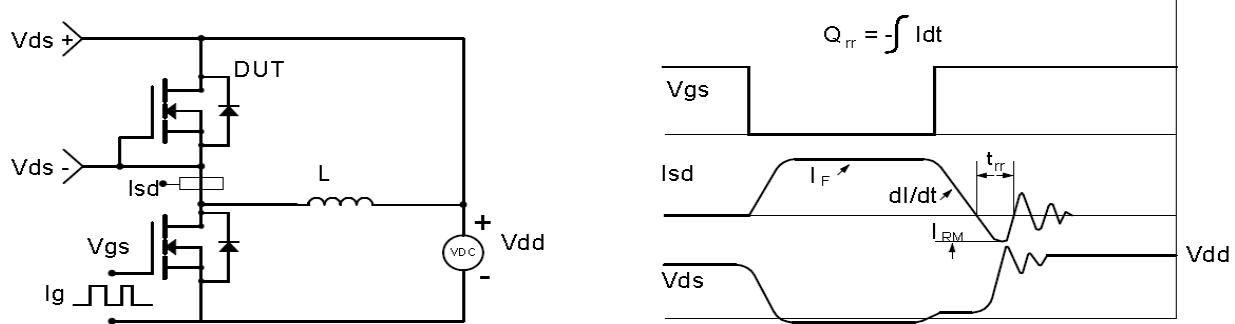
Resistive Switching Test Circuit & Waveforms

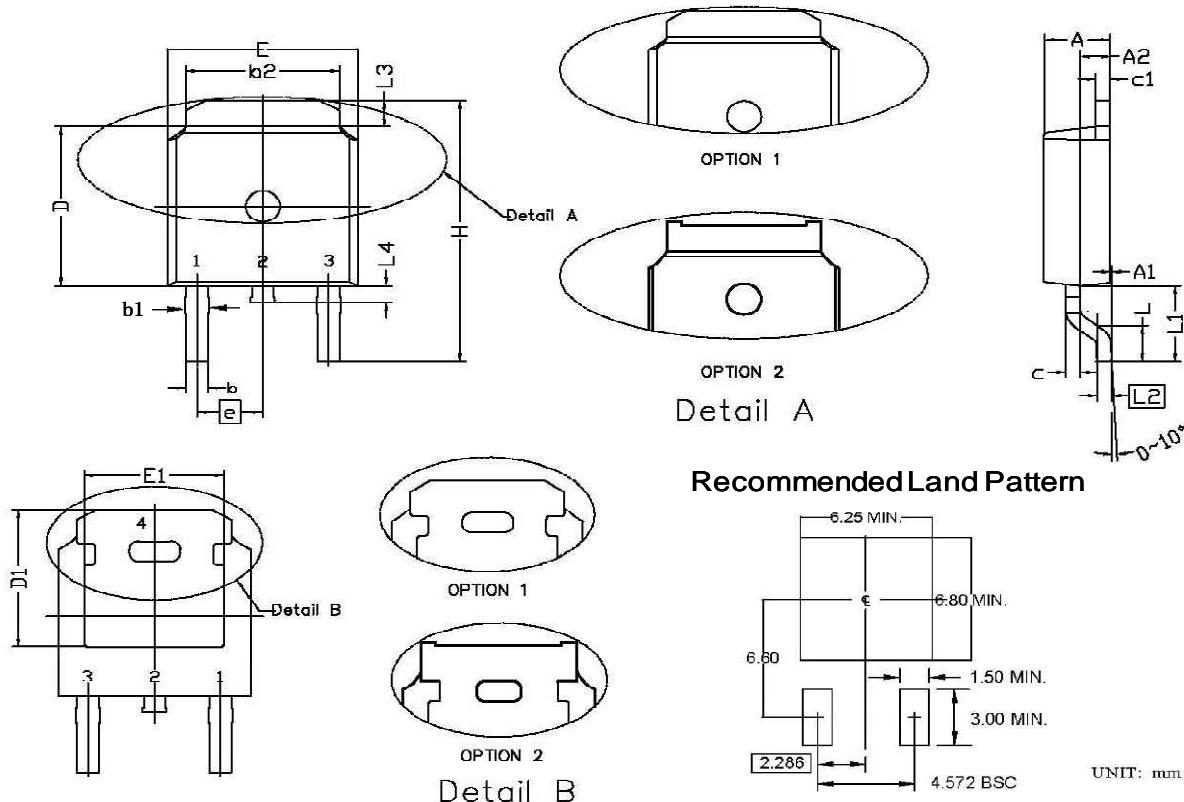


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: TO-252


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.15	2.45	0.085	0.096
A1	0.00	0.15	0.000	0.006
A2	0.76	1.36	0.030	0.054
b	0.60	0.91	0.024	0.036
b1	0.65	1.15	0.026	0.045
b2	5.00	5.64	0.197	0.222
c	0.45	0.61	0.018	0.024
c1	0.36	0.66	0.014	0.026
D	5.80	6.30	0.228	0.248
D1	5.00	6.00	0.197	0.236
e	2.29 BSC.		0.090 BSC.	
E	6.30	6.90	0.248	0.272
E1	4.55	5.30	0.179	0.209
H	9.40	10.48	0.370	0.413
L	1.18	1.70	0.046	0.067
L1	2.92 REF		0.115 REF	
L2	0.36	0.66	0.014	0.026
L3	0.72	1.35	0.028	0.053
L4	0.60	1.20	0.024	0.047



华润微电子(重庆)有限公司

CRTD082NE6N

Trench N-MOSFET 65V, 6.9mΩ, 85A

Revision History

Revison	Date	Major changes
1.0	2021-1-12	Release of formal version

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

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